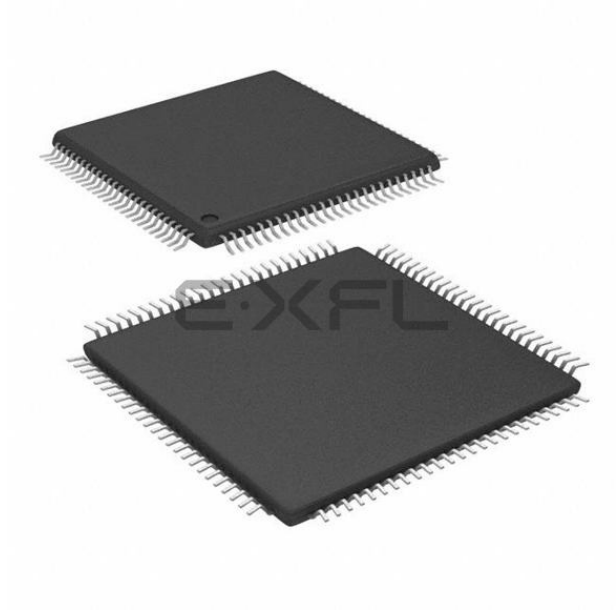
Microchip Technology - PIC32MZ1024EFG100-I/PT Datasheet



Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	MIPS32® M-Class
Core Size	32-Bit Single-Core
Speed	200MHz
Connectivity	EBI/EMI, Ethernet, I²C, PMP, SPI, SQI, UART/USART, USB OTG
Peripherals	Brown-out Detect/Reset, DMA, I²S, POR, PWM, WDT
Number of I/O	78
Program Memory Size	1MB (1M x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512K x 8
Voltage - Supply (Vcc/Vdd)	2.1V ~ 3.6V
Data Converters	A/D 40x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TQFP
Supplier Device Package	100-TQFP (12x12)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic32mz1024efg100-i-pt

2.0 GUIDELINES FOR GETTING STARTED WITH 32-BIT MICROCONTROLLERS

Note 1: This data sheet summarizes the features of the PIC32MZ EF family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the *"PIC32 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com/PIC32).

2.1 Basic Connection Requirements

Getting started with the PIC32MZ EF family of 32-bit Microcontrollers (MCUs) requires attention to a minimal set of device pin connections before proceeding with development. The following is a list of pin names, which must always be connected:

- All VDD and VSS pins (see **2.2 "Decoupling Capacitors"**)
- All AVDD and AVSS pins, even if the ADC module is not used (see **2.2 "Decoupling Capacitors"**)
- $\overline{\text{MCLR}}$ pin (see **2.3 "Master Clear (MCLR) Pin"**)
- PGECx/PGEDx pins, used for In-Circuit Serial Programming™ (ICSP™) and debugging purposes (see **2.4 "ICSP Pins"**)
- OSC1 and OSC2 pins, when external oscillator source is used (see **2.7 "External Oscillator Pins"**)

The following pin(s) may be required as well:

VREF+/VREF- pins, used when external voltage reference for the ADC module is implemented.

Note: The AVDD and AVSS pins must be connected, regardless of ADC use and the ADC voltage reference source.

2.2 Decoupling Capacitors

The use of decoupling capacitors on power supply pins, such as VDD, VSS, AVDD and AVSS is required. See Figure 2-1.

Consider the following criteria when using decoupling capacitors:

- **Value and type of capacitor:** A value of 0.1 µF (100 nF), 10-20V is recommended. The capacitor should be a low Equivalent Series Resistance (low-ESR) capacitor and have resonance frequency in the range of 20 MHz and higher. It is further recommended that ceramic capacitors be used.
- **Placement on the printed circuit board:** The decoupling capacitors should be placed as close to the pins as possible. It is recommended that the capacitors be placed on the same side of the board as the device. If space is constricted, the capacitor can be placed on another layer on the PCB using a via; however, ensure that the trace length from the pin to the capacitor is within one-quarter inch (6 mm) in length.
- **Handling high frequency noise:** If the board is experiencing high frequency noise, upward of tens of MHz, add a second ceramic-type capacitor in parallel to the above described decoupling capacitor. The value of the second capacitor can be in the range of 0.01 µF to 0.001 µF. Place this second capacitor next to the primary decoupling capacitor. In high-speed circuit designs, consider implementing a decade pair of capacitances as close to the power and ground pins as possible. For example, 0.1 µF in parallel with 0.001 µF.
- **Maximizing performance:** On the board layout from the power supply circuit, run the power and return traces to the decoupling capacitors first, and then to the device pins. This ensures that the decoupling capacitors are first in the power chain. Equally important is to keep the trace length between the capacitor and the power pins to a minimum thereby reducing PCB track inductance.

4.1.1 BOOT FLASH SEQUENCE AND CONFIGURATION SPACES

Sequence space is used to identify which boot Flash is aliased by aliased regions. If the value programmed into the TSEQ<15:0> bits of the BF1SEQ3 word is equal to or greater than the value programmed into the TSEQ<15:0> bits of the BF2SEQ3 word, boot Flash 1 is aliased by the lower boot alias region, and boot Flash 2 is aliased by the upper boot alias region. If the TSEQ<15:0> bits of the BF2SEQ3 word is greater than the TSEQ<15:0> bits of the BF1SEQ3 word, the opposite is true (see Table 4-2 and Table 4-3 for BFxSEQ3 word memory locations).

The CSEQ<15:0> bits must contain the one's complement value of the TSEQ<15:0> bits; otherwise, the value of the TSEQ<15:0> bits is considered invalid, and an alternate sequence is used. See **Section 4.1.2 "Alternate Sequence and Configuration Words"** for more information.

Once boot Flash memories are aliased, configuration space located in the lower boot alias region is used as the basis for the Configuration words, DEVSIGN0, DEVCP0, and DEVCFGx (and the associated alternate configuration registers). This means that the boot Flash region to be aliased by lower boot alias region memory must contain configuration values in the appropriate memory locations.

Note:	Do not use word program operation (NVMOP<3:0> = `0001`) when programming data into the sequence and configuration spaces.

4.1.2 ALTERNATE SEQUENCE AND CONFIGURATION WORDS

Every word in the configuration space and sequence space has an associated alternate word (designated by the letter A as the first letter in the name of the word). During device start-up, primary words are read and if uncorrectable ECC errors are found, the BCFGERR (RCON<27>) flag is set and alternate words are used. If uncorrectable ECC errors are found in primary and alternate words, the BCFGFAIL (RCON<26>) flag is set and the default configuration is used.

TABLE 7-3: INTERRUPT REGISTER MAP (CONTINUED)

Virtual Address (BF81_#)	Register Name(1)	Bit Range	Bits															All Resets
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	
02E0	IPC26	31:16	—	—	—	CRPTIP<2:0>(7)			CRPTIS<1:0>(7)		—	—	—	SBIP<2:0>			SBIS<1:0>		0000
		15:0	—	—	—	CFDCIP<2:0>			CFDCIS<1:0>		—	—	—	CPCIP<2:0>			CPCIS<1:0>		0000
02F0	IPC27	31:16	—	—	—	SPI1TXIP<2:0>			SPI1TXIS<1:0>		—	—	—	SPI1RXIP<2:0>			SPI1RXIS<1:0>		0000
		15:0	—	—	—	SPI1EIP<2:0>			SPI1EIS<1:0>		—	—	—	—	—	—	—	—	0000
0300	IPC28	31:16	—	—	—	I2C1BIP<2:0>			I2C1BIS<1:0>		—	—	—	U1TXIP<2:0>			U1TXIS<1:0>		0000
		15:0	—	—	—	U1RXIP<2:0>			U1RXIS<1:0>		—	—	—	U1EIP<2:0>			U1EIS<1:0>		0000
0310	IPC29	31:16	—	—	—	CNBIP<2:0>			CNBIS<1:0>		—	—	—	CNAIP<2:0>(2)			CNAIS<1:0>(2)		0000
		15:0	—	—	—	I2C1MIP<2:0>			I2C1MIS<1:0>		—	—	—	I2C1SIP<2:0>			I2C1SIS<1:0>		0000
0320	IPC30	31:16	—	—	—	CNFIP<2:0>			CNFIS<1:0>		—	—	—	CNEIP<2:0>			CNEIS<1:0>		0000
		15:0	—	—	—	CNDIP<2:0>			CNDIS<1:0>		—	—	—	CNCIP<2:0>			CNCIS<1:0>		0000
0330	IPC31	31:16	—	—	—	CNKIP<2:0>(2,4,8)			CNKIS<1:0>(2,4,8)		—	—	—	CNJIP<2:0>(2,4)			CNJIS<1:0>(2,4)		0000
		15:0	—	—	—	CNHIP<2:0>(2,4)			CNHIS<1:0>(2,4)		—	—	—	CNGIP<2:0>			CNGIS<1:0>		0000
0340	IPC32	31:16	—	—	—	CMP2IP<2:0>			CMP2IS<1:0>		—	—	—	CMP1IP<2:0>			CMP1IS<1:0>		0000
		15:0	—	—	—	PMPEIP<2:0>			PMPEIS<1:0>		—	—	—	PMPIP<2:0>			PMPIS<1:0>		0000
0350	IPC33	31:16	—	—	—	DMA1IP<2:0>			DMA1IS<1:0>		—	—	—	DMA0IP<2:0>			DMA0IS<1:0>		0000
		15:0	—	—	—	USBDMAIP<2:0>			USBDMAIS<1:0>		—	—	—	USBIP<2:0>			USBIS<1:0>		0000
0360	IPC34	31:16	—	—	—	DMA5IP<2:0>			DMA5IS<1:0>		—	—	—	DMA4IP<2:0>			DMA4IS<1:0>		0000
		15:0	—	—	—	DMA3IP<2:0>			DMA3IS<1:0>		—	—	—	DMA2IP<2:0>			DMA2IS<1:0>		0000
0370	IPC35	31:16	—	—	—	SPI2RXIP<2:0>			SPI2RXIS<1:0>		—	—	—	SPI2EIP<2:0>			SPI2EIS<1:0>		0000
		15:0	—	—	—	DMA7IP<2:0>			DMA7IS<1:0>		—	—	—	DMA6IP<2:0>			DMA6IS<1:0>		0000
0380	IPC36	31:16	—	—	—	U2TXIP<2:0>			U2TXIS<1:0>		—	—	—	U2RXIP<2:0>			U2RXIS<1:0>		0000
		15:0	—	—	—	U2EIP<2:0>			U2EIS<1:0>		—	—	—	SPI2TXIP<2:0>			SPI2TXIS<1:0>		0000
0390	IPC37	31:16	—	—	—	CAN1IP<2:0>(3)			CAN1IS<1:0>(3)		—	—	—	I2C2MIP<2:0>(2)			I2C2MIS<1:0>(2)		0000
		15:0	—	—	—	I2C2SIP<2:0>(2)			I2C2SIS<1:0>(2)		—	—	—	I2C2BIP<2:0>(2)			I2C2BIS<1:0>(2)		0000
03A0	IPC38	31:16	—	—	—	SPI3RXIP<2:0>			SPI3RXIS<1:0>		—	—	—	SPI3EIP<2:0>			SPI3EIS<1:0>		0000
		15:0	—	—	—	ETHIP<2:0>			ETHIS<1:0>		—	—	—	CAN2IP<2:0>(3)			CAN2IS<1:0>(3)		0000
03B0	IPC39	31:16	—	—	—	U3TXIP<2:0>			U3TXIS<1:0>		—	—	—	U3RXIP<2:0>			U3RXIS<1:0>		0000
		15:0	—	—	—	U3EIP<2:0>			U3EIS<1:0>		—	—	—	SPI3TXIP<2:0>			SPI3TXIS<1:0>		0000
03C0	IPC40	31:16	—	—	—	SPI4EIP<2:0>			SPI4EIS<1:0>		—	—	—	I2C3MIP<2:0>			I2C3MIS<1:0>		0000
		15:0	—	—	—	I2C3SIP<2:0>			I2C3SIS<1:0>		—	—	—	I2C3BIP<2:0>			I2C3BIS<1:0>		0000

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table with the exception of the OFFx registers, have corresponding CLR, SET, and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See **Section 12.3 "CLR, SET, and INV Registers"** for more information.
2: This bit or register is not available on 64-pin devices.
3: This bit or register is not available on devices without a CAN module.
4: This bit or register is not available on 100-pin devices.
5: Bits 31 and 30 are not available on 64-pin and 100-pin devices; bits 29 through 14 are not available on 64-pin devices.
6: Bits 31, 30, 29, and bits 5 through 0 are not available on 64-pin and 100-pin devices; bit 31 is not available on 124-pin devices; bit 22 is not available on 64-pin devices.
7: This bit or register is not available on devices without a Crypto module.
8: This bit or register is not available on 124-pin devices.

TABLE 12-13: PORTF REGISTER MAP FOR 100-PIN, 124-PIN, AND 144-PIN DEVICES ONLY

Virtual Address (BF86_#)	Register Name(1)	Bit Range	Bits																All Resets
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	
0500	ANSELF	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	ANSF13	ANSF12	—	—	—	—	—	—	—	—	—	—	—	—	3000
0510	TRISF	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	TRISF13	TRISF12	—	—	—	TRISF8	—	—	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1	TRISF0	313F
0520	PORTF	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	RF13	RF12	—	—	—	RF8	—	—	RF5	RF4	RF3	RF2	RF1	RF0	xxxx
0530	LATF	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	LATF13	LATF12	—	—	—	LATF8	—	—	LATF5	LATF4	LATF3	LATF2	LATF1	LATF0	xxxx
0540	ODCF	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	ODCF13	ODCF12	—	—	—	ODCF8	—	—	ODCF5	ODCF4	ODCF3	ODCF2	ODCF1	ODCF0	0000
0550	CNPUF	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	CNPUF13	CNPUF12	—	—	—	CNPUF8	—	—	CNPUF5	CNPUF4	CNPUF3	CNPUF2	CNPUF1	CNPUF0	0000
0560	CNPDF	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	CNPDF13	CNPDF12	—	—	—	CNPDF8	—	—	CNPDF5	CNPDF4	CNPDF3	CNPDF2	CNPDF1	CNPDF0	0000
0570	CNCONF	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	ON	—	—	—	EDGE DETECT	—	—	—	—	—	—	—	—	—	—	—	0000
0580	CNENF	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	CNENF13	CNENF12	—	—	—	CNENF8	—	—	CNENF5	CNENF4	CNENF3	CNENF2	CNENF1	CNENF0	0000
0590	CNSTATF	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	CN STATF13	CN STATF12	—	—	—	CN STATF8	—	—	CN STATF5	CN STATF4	CN STATF3	CN STATF2	CN STATF1	CN STATF0	0000
05A0	CNNEF	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	CNNEF13	CNNEF12	—	—	—	CNNEF8	—	—	CNNEF5	CNNEF4	CNNEF3	CNNEF2	CNNEF1	CNNEF0	0000
05B0	CNFF	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	CNFF13	CNFF12				CNFF8			CNFF5	CNFF4	CNFF3	CNFF2	CNFF1	CNFF0	0000
05C0	SRCON0F	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	—	—	—	—	—	—	—	SR0F1	SR0F0	0000
05D0	SRCON1F	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	—	—	—	—	—	—	—	SR1F1	SR1F0	0000

Legend: x = Unknown value on Reset; — = Unimplemented, read as '0'; Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at its virtual address, plus an offset of 0x4, 0x8 and 0xC, respectively. See **Section 12.3 "CLR, SET, and INV Registers"** for more information.

REGISTER 13-1: T1CON: TYPE A TIMER CONTROL REGISTER (CONTINUED)

bit 2 **TSYNC:** Timer External Clock Input Synchronization Selection bit

When TCS = 1:
1 = External clock input is synchronized
0 = External clock input is not synchronized

When TCS = 0:
This bit is ignored.

bit 1 **TCS:** Timer Clock Source Select bit

1 = External clock from T1CKI pin
0 = Internal peripheral clock

bit 0 **Unimplemented:** Read as '0'

18.1 Output Compare Control Registers

TABLE 18-2: OUTPUT COMPARE 1 THROUGH OUTPUT COMPARE 9 REGISTER MAP

Virtual Address (BF84_#)	Register Name(1)	Bit Range	Bits																All Resets
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	
4000	OC1CON	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	ON	—	SIDL	—	—	—	—	—	—	—	OC32	OCFLT	OCTSEL	OCM<2:0>			0000
4010	OC1R	31:16	OC1R<31:0>																xxxx
		15:0																	xxxx
4020	OC1RS	31:16	OC1RS<31:0>																xxxx
		15:0																	xxxx
4200	OC2CON	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	ON	—	SIDL	—	—	—	—	—	—	—	OC32	OCFLT	OCTSEL	OCM<2:0>			0000
4210	OC2R	31:16	OC2R<31:0>																xxxx
		15:0																	xxxx
4220	OC2RS	31:16	OC2RS<31:0>																xxxx
		15:0																	xxxx
4400	OC3CON	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	ON	—	SIDL	—	—	—	—	—	—	—	OC32	OCFLT	OCTSEL	OCM<2:0>			0000
4410	OC3R	31:16	OC3R<31:0>																xxxx
		15:0																	xxxx
4420	OC3RS	31:16	OC3RS<31:0>																xxxx
		15:0																	xxxx
4600	OC4CON	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	ON	—	SIDL	—	—	—	—	—	—	—	OC32	OCFLT	OCTSEL	OCM<2:0>			0000
4610	OC4R	31:16	OC4R<31:0>																xxxx
		15:0																	xxxx
4620	OC4RS	31:16	OC4RS<31:0>																xxxx
		15:0																	xxxx
4800	OC5CON	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	ON	—	SIDL	—	—	—	—	—	—	—	OC32	OCFLT	OCTSEL	OCM<2:0>			0000
4810	OC5R	31:16	OC5R<31:0>																xxxx
		15:0																	xxxx
4820	OC5RS	31:16	OC5RS<31:0>																xxxx
		15:0																	xxxx

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See **Section 12.3 "CLR, SET, and INV Registers"** for more information.

REGISTER 20-4: SQI1CON: SQI CONTROL REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	r-0	R/W-0
	—	—	—	—	—	—	—	SCHECK
23:16	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	—	DASSERT	DEVSEL<1:0>		LANEMODE<1:0>		CMDINIT<1:0>	
15:8	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	TXRXCOUNT<15:8>							
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	TXRXCOUNT<7:0>							

Legend:	r = Reserved		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-26 **Unimplemented:** Read as '0'

bit 25 **Reserved:** Must be programmed as '0'

bit 24 **SCHECK:** Flash Status Check bit
1 = Check the status of the Flash
0 = Do not check the status of the Flash

bit 23 **Unimplemented:** Read as '0'

bit 22 **DASSERT:** Chip Select Assert bit
1 = Chip Select is deasserted after transmission or reception of the specified number of bytes
0 = Chip Select is not deasserted after transmission or reception of the specified number of bytes

bit 21-20 **DEVSEL<1:0>:** SQI Device Select bits
11 = Reserved
10 = Reserved
01 = Select Device 1
00 = Select Device 0

bit 19-18 **LANEMODE<1:0>:** SQI Lane Mode Select bits
11 = Reserved
10 = Quad Lane mode
01 = Dual Lane mode
00 = Single Lane mode

bit 17-16 **CMDINIT<1:0>:** Command Initiation Mode Select bits
If it is Transmit, commands are initiated based on a write to the transmit register or the contents of TX FIFO. If CMDINIT is Receive, commands are initiated based on reads to the read register or RX FIFO availability.
11 = Reserved
10 = Receive
01 = Transmit
00 = Idle

bit 15-0 **TXRXCOUNT<15:0>:** Transmit/Receive Count bits
These bits specify the total number of bytes to transmit or receive (based on CMDINIT).

REGISTER 20-26: SQI1XCON4: SQI XIP CONTROL REGISTER 4

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	—	—	—	INIT2SCHECK	INIT2COUNT<1:0>		INIT2TYPE<1:0>	
23:16	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	INIT2CMD3<7:0>(1)							
15:8	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	INIT2CMD2<7:0>(1)							
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	INIT2CMD1<7:0>(1)							

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-29 **Unimplemented:** Read as '0'

bit 28 **INIT2SCHECK:** Flash Initialization 2 Command Status Check bit
1 = Check the status after executing the INIT2 command
0 = Do not check the status

bit 27-26 **INIT2COUNT<1:0>:** Flash Initialization 2 Command Count bits
11 = INIT2CMD1, INIT2CMD2, and INIT2CMD3 are sent
10 = INIT2CMD1 and INIT2CMD2 are sent, but INIT2CMD3 is still pending
01 = INIT2CMD1 is sent, but INIT2CMD2 and INIT2CMD3 are still pending
00 = No commands are sent

bit 25-24 **INIT2TYPE<1:0>:** Flash Initialization 2 Command Type bits
11 = Reserved
10 = INIT2 commands are sent in Quad Lane mode
01 = INIT2 commands are sent in Dual Lane mode
00 = INIT2 commands are sent in Single Lane mode

bit 24-16 **INIT2CMD3<7:0>:** Flash Initialization Command 3 bits(1)
Third command of the Flash initialization.

bit 15-8 **INIT2CMD2<7:0>:** Flash Initialization Command 2 bits(1)
Second command of the Flash initialization.

bit 7-0 **INIT2CMD1<7:0>:** Flash Initialization Command 1 bits(1)
First command of the Flash initialization.

Note 1: INIT2CMD1 can be WEN and INIT2CMD2 can be SECTOR UNPROTECT.

Note: Some Flash devices require Write Enable and Sector Unprotect commands before read/write operations and this register is useful in working with those Flash types (XIP mode only)

FIGURE 21-1: I²C BLOCK DIAGRAM

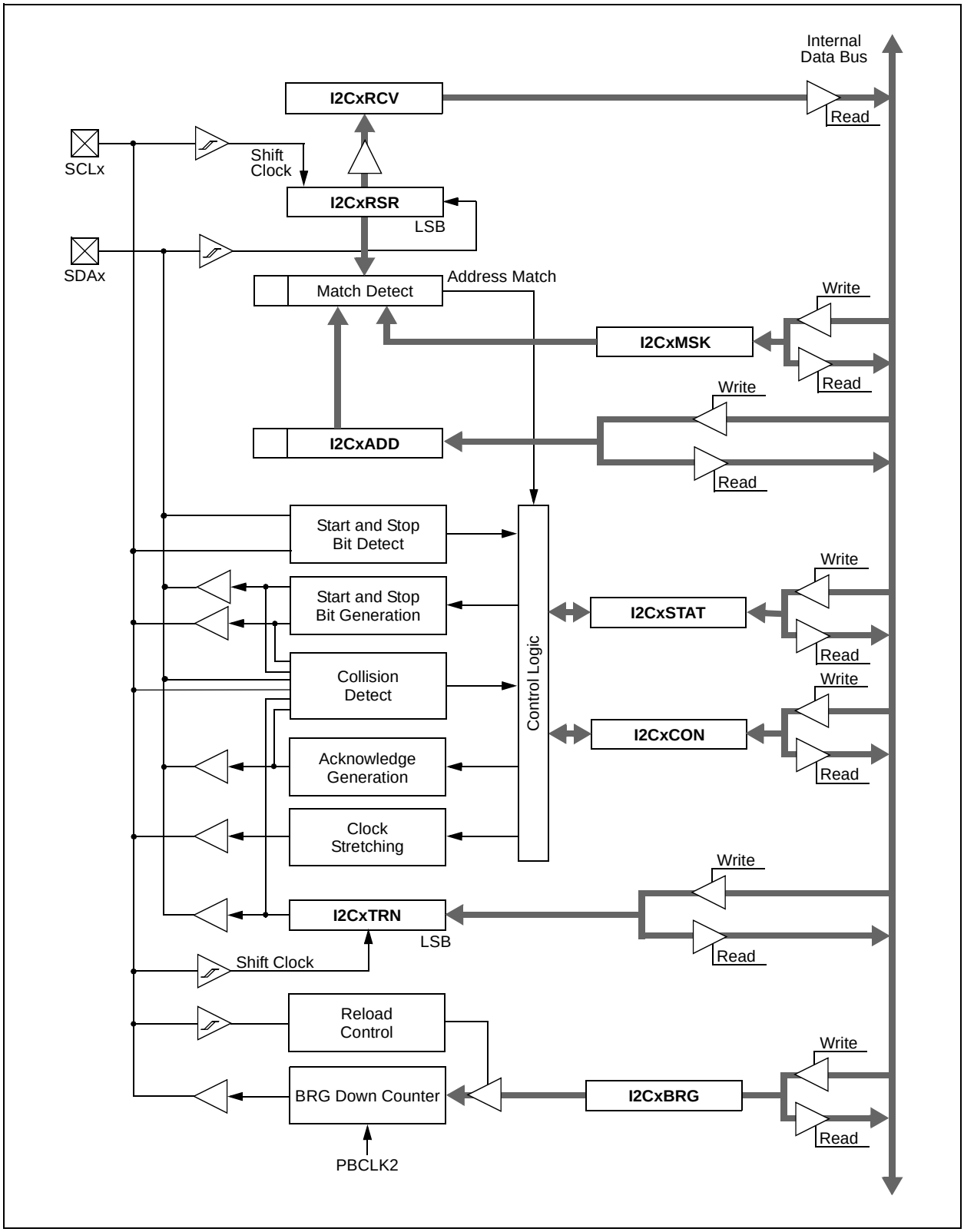


Figure 22-2 and Figure 22-3 illustrate the typical receive and transmit timing for the UART module.

FIGURE 22-2: UART RECEPTION

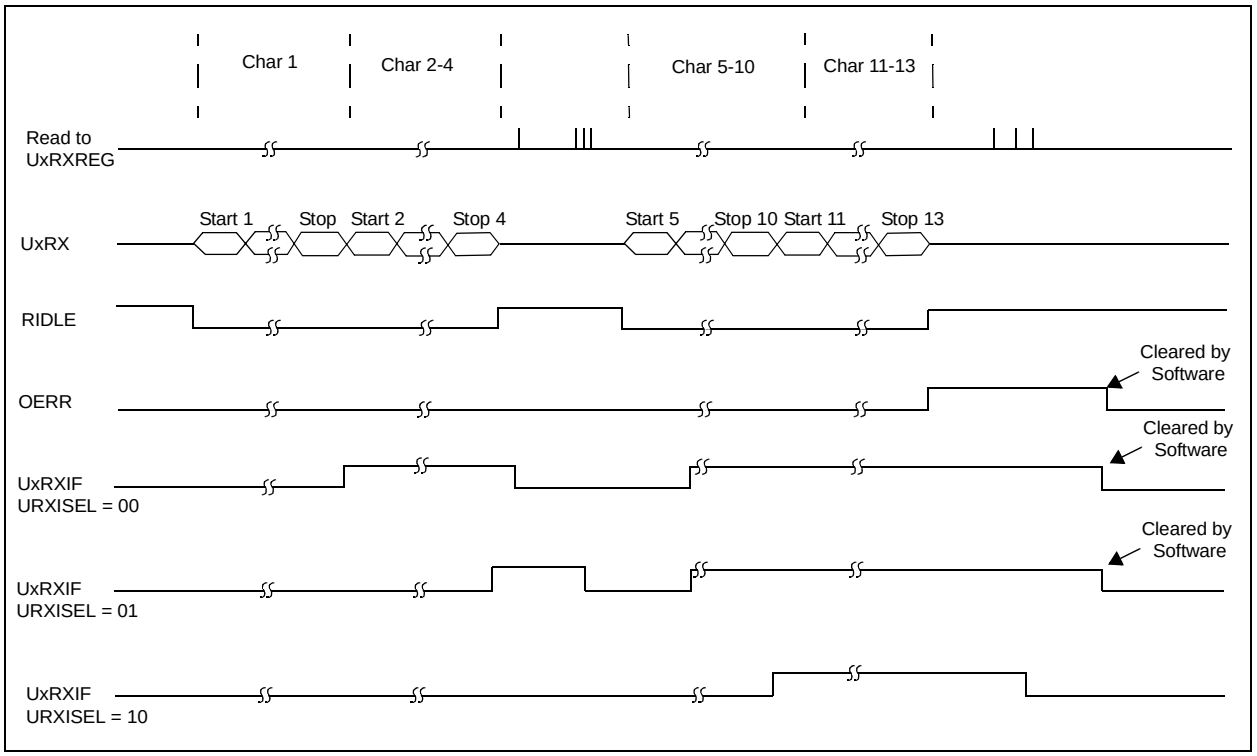
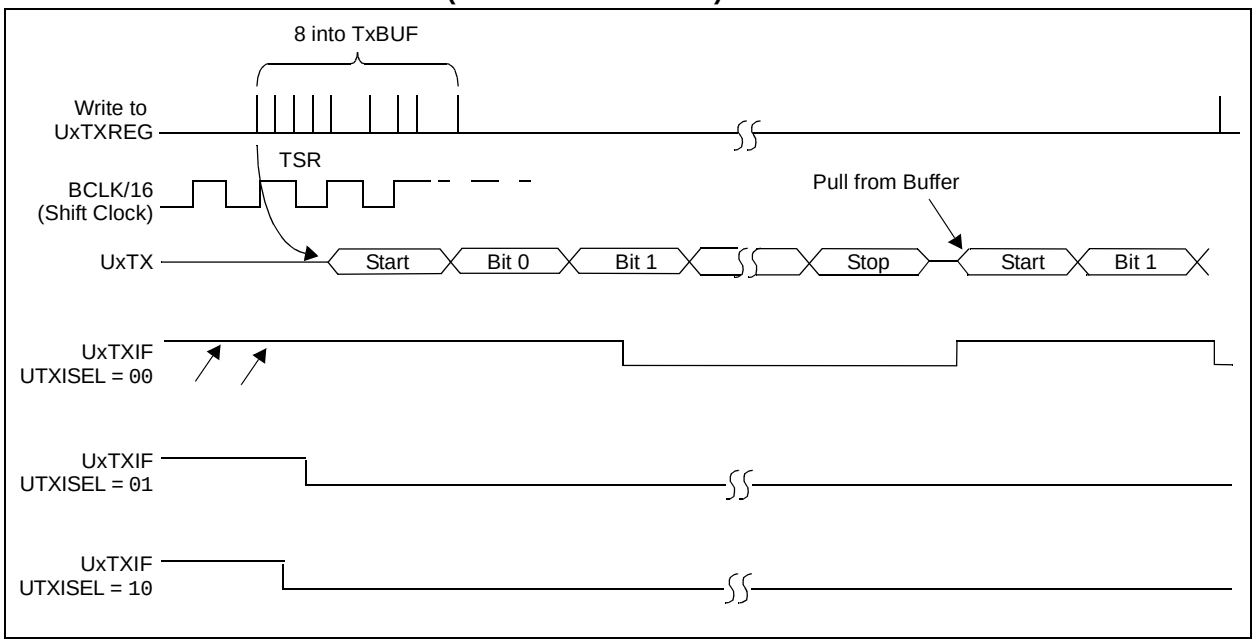


FIGURE 22-3: TRANSMISSION (8-BIT OR 9-BIT DATA)



REGISTER 25-2: RTCALRM: REAL-TIME CLOCK ALARM CONTROL REGISTER (CONTINUED)

bit 7-0 **ARPT<7:0>:** Alarm Repeat Counter Value bits(2)

11111111 = Alarm will trigger 256 times
•
•
•
00000000 = Alarm will trigger one time
The counter decrements on any alarm event. The counter only rolls over from 0x00 to 0xFF if CHIME = 1.

Note 1: Hardware clears the ALRMEN bit anytime the alarm event occurs, when ARPT<7:0> = 00 and CHIME = 0.

2: This field should not be written when the RTCC ON bit = '1' (RTCCON<15>) and ALRMSYNC = 1.

Note:	This register is reset only on a Power-on Reset (POR).

REGISTER 25-5: ALRMTIME: ALARM TIME VALUE REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
	HR10<3:0>				HR01<3:0>			
23:16	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
	MIN10<3:0>				MIN01<3:0>			
15:8	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
	SEC10<3:0>				SEC01<3:0>			
7:0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-28 **HR10<3:0>:** Binary Coded Decimal value of hours bits, 10 digits; contains a value from 0 to 2

bit 27-24 **HR01<3:0>:** Binary Coded Decimal value of hours bits, 1 digit; contains a value from 0 to 9

bit 23-20 **MIN10<3:0>:** Binary Coded Decimal value of minutes bits, 10 digits; contains a value from 0 to 5

bit 19-16 **MIN01<3:0>:** Binary Coded Decimal value of minutes bits, 1 digit; contains a value from 0 to 9

bit 15-12 **SEC10<3:0>:** Binary Coded Decimal value of seconds bits, 10 digits; contains a value from 0 to 5

bit 11-8 **SEC01<3:0>:** Binary Coded Decimal value of seconds bits, 1 digit; contains a value from 0 to 9

bit 7-0 **Unimplemented:** Read as '0'

Figure 26-10: Format of SA_CTRL (Continued)

bit 16-10 **ALGO<6:0>:** Type of Algorithm to Use
1xxxxxx = HMAC 1
x1xxxxx = SHA-256
xx1xxxx = SHA1
xxx1xxx = MD5
xxxx1xx = AES
xxxxx1x = TDES
xxxxxx1 = DES

bit 9 **ENC:** Type of Encryption Setting
1 = Encryption
0 = Decryption

bit 8-7 **KEYSIZE<1:0>:** Size of Keys in SA_AUTHKEYx or SA_ENCKEYx
11 = Reserved; do not use
10 = 256 bits
01 = 192 bits
00 = 128 bits(1)

bit 6-4 **MULTITASK<2:0>:** How to Combine Parallel Operations in the Crypto Engine
111 = Parallel pass (decrypt and authenticate incoming data in parallel)
101 = Pipe pass (encrypt the incoming data, and then perform authentication on the encrypted data)
011 = Reserved
010 = Reserved
001 = Reserved
000 = Encryption or authentication or decryption (no pass)

bit 3-0 **CRYPTOALGO<3:0>:** Mode of operation for the Crypto Algorithm
1111 = Reserved
1110 = AES_GCM (for AES processing)
1101 = RCTR (for AES processing)
1100 = RCBC_MAC (for AES processing)
1011 = ROFB (for AES processing)
1010 = RCFB (for AES processing)
1001 = RCBC (for AES processing)
1000 = RECB (for AES processing)
0111 = TOFB (for Triple-DES processing)
0110 = TCFB (for Triple-DES processing)
0101 = TCBC (for Triple-DES processing)
0100 = TECB (for Triple-DES processing)
0011 = OFB (for DES processing)
0010 = CFB (for DES processing)
0001 = CBC (for DES processing)
0000 = ECB (for DES processing)

Note 1: This setting does not alter the size of SA_AUTHKEYx or SA_ENCKEYx in the Security Association, only the number of bits of SA_AUTHKEYx and SA_ENCKEYx that are used.

REGISTER 30-20: ETHFRMRXOK: ETHERNET CONTROLLER FRAMES RECEIVED OK STATISTICS REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	FRMRXOKCNT<15:8>							
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	FRMRXOKCNT<7:0>							

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 **Unimplemented:** Read as '0'

bit 15-0 **FRMRXOKCNT<15:0>:** Frames Received OK Count bits

Increment count for frames received successfully by the RX Filter. This count will not be incremented if there is a Frame Check Sequence (FCS) or Alignment error.

Note 1: This register is only used for RX operations.

2: This register is automatically cleared by hardware after a read operation, unless the byte enables for bytes 0/1 are '0'.

3: It is recommended to use the SET, CLR, or INV registers to set or clear any bit in this register. Setting or clearing any bits in this register should only be done for debug/test purposes.

REGISTER 32-1: CVRCON: COMPARATOR VOLTAGE REFERENCE CONTROL REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	R/W-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	ON	—	—	—	—	—	—	—
7:0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	—	CVROE	CVRR	CVRSS	CVR<3:0>			

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 **Unimplemented:** Read as '0'

bit 15 **ON:** Comparator Voltage Reference On bit
- 1 = Module is enabled
  Setting this bit does not affect other bits in the register.
- 0 = Module is disabled and does not consume current.
  Clearing this bit does not affect the other bits in the register.

bit 14-7 **Unimplemented:** Read as '0'

bit 6 **CVROE:** CV_{REFOUT} Enable bit
- 1 = Voltage level is output on CV_{REFOUT} pin
- 0 = Voltage level is disconnected from CV_{REFOUT} pin

bit 5 **CVRR:** CV_{REF} Range Selection bit
- 1 = 0 to 0.67 CV_{RSRC}, with $CV_{RSRC}/24$ step size
- 0 = 0.25 CV_{RSRC} to 0.75 CV_{RSRC}, with $CV_{RSRC}/32$ step size

bit 4 **CVRSS:** CV_{REF} Source Selection bit
- 1 = Comparator voltage reference source, $CV_{RSRC} = (V_{REF}+) – (V_{REF}-)$
- 0 = Comparator voltage reference source, $CV_{RSRC} = AV_{DD} – AV_{SS}$

bit 3-0 **CVR<3:0>:** CV_{REF} Value Selection $0 \le CVR<3:0> \le 15$ bits

When CVRR = 1:
$CV_{REF} = (CVR<3:0>/24) \bullet (CV_{RSRC})$

When CVRR = 0:
$CV_{REF} = 1/4 \bullet (CV_{RSRC}) + (CVR<3:0>/32) \bullet (CV_{RSRC})$

TABLE 37-33: SPIx MODULE SLAVE MODE (CKE = 1) TIMING REQUIREMENTS (CONTINUED)

AC CHARACTERISTICS			Standard Operating Conditions: 2.1V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param. No.	**Symbol**	**Characteristics(1)**	**Min.**	**Typical(2)**	**Max.**	**Units**	**Conditions**
SP50	TssL2scH, TssL2scL	$\overline{SSx}$ ↓ to SCKx ↓ or SCKx ↑ Input	88	—	—	ns	—
SP51	TssH2doZ	$\overline{SSx}$ ↑ to SDOx Output High-Impedance **(Note 4)**	2.5	—	12	ns	—
SP52	TscH2ssH TscL2ssH	$\overline{SSx}$ ↑ after SCKx Edge	10	—	—	ns	—
SP60	TssL2doV	SDOx Data Output Valid after $\overline{SSx}$ Edge	—	—	12.5	ns	—

Note 1: These parameters are characterized, but not tested in manufacturing.

2: Data in "Typical" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

3: The minimum clock period for SCKx is 20 ns.

4: Assumes 30 pF load on all SPIx pins.

TABLE 37-36: I2Cx BUS DATA TIMING REQUIREMENTS (SLAVE MODE) (CONTINUED)

AC CHARACTERISTICS				Standard Operating Conditions: 2.1V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended			
Param. No.	**Symbol**	**Characteristics**		**Min.**	**Max.**	**Units**	**Conditions**
IS20	TF:SCL	SDAx and SCLx Fall Time	100 kHz mode	—	300	ns	CB is specified to be from 10 to 400 pF
			400 kHz mode	20 + 0.1 CB	300	ns	
			1 MHz mode **(Note 1)**	—	100	ns	
IS21	TR:SCL	SDAx and SCLx Rise Time	100 kHz mode	—	1000	ns	CB is specified to be from 10 to 400 pF
			400 kHz mode	20 + 0.1 CB	300	ns	
			1 MHz mode **(Note 1)**	—	300	ns	
IS25	TSU:DAT	Data Input Setup Time	100 kHz mode	250	—	ns	—
			400 kHz mode	100	—	ns	
			1 MHz mode **(Note 1)**	100	—	ns	
IS26	THD:DAT	Data Input Hold Time	100 kHz mode	0	—	ns	—
			400 kHz mode	0	0.9	µs	
			1 MHz mode **(Note 1)**	0	0.3	µs	
IS30	TSU:STA	Start Condition Setup Time	100 kHz mode	4700	—	ns	Only relevant for Repeated Start condition
			400 kHz mode	600	—	ns	
			1 MHz mode **(Note 1)**	250	—	ns	
IS31	THD:STA	Start Condition Hold Time	100 kHz mode	4000	—	ns	After this period, the first clock pulse is generated
			400 kHz mode	600	—	ns	
			1 MHz mode **(Note 1)**	250	—	ns	
IS33	TSU:STO	Stop Condition Setup Time	100 kHz mode	4000	—	ns	—
			400 kHz mode	600	—	ns	
			1 MHz mode **(Note 1)**	600	—	ns	
IS34	THD:STO	Stop Condition Hold Time	100 kHz mode	4000	—	ns	—
			400 kHz mode	600	—	ns	
			1 MHz mode **(Note 1)**	250		ns	
IS40	TAA:SCL	Output Valid from Clock	100 kHz mode	0	3500	ns	—
			400 kHz mode	0	1000	ns	
			1 MHz mode **(Note 1)**	0	350	ns	
IS45	TBF:SDA	Bus Free Time	100 kHz mode	4.7	—	µs	The amount of time the bus must be free before a new transmission can start
			400 kHz mode	1.3	—	µs	
			1 MHz mode **(Note 1)**	0.5	—	µs	
IS50	CB	Bus Capacitive Loading		—	—	pF	See parameter DO58

Note 1: Maximum pin capacitance = 10 pF for all I2Cx pins (for 1 MHz mode only).

FIGURE 40-5: VOH – 12x DRIVER PINS

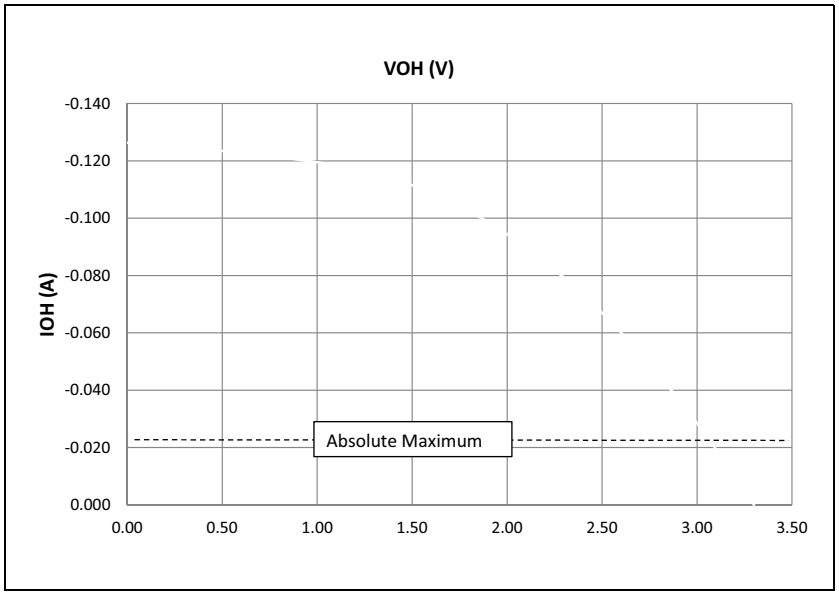


FIGURE 40-6: VOL – 12x DRIVER PINS

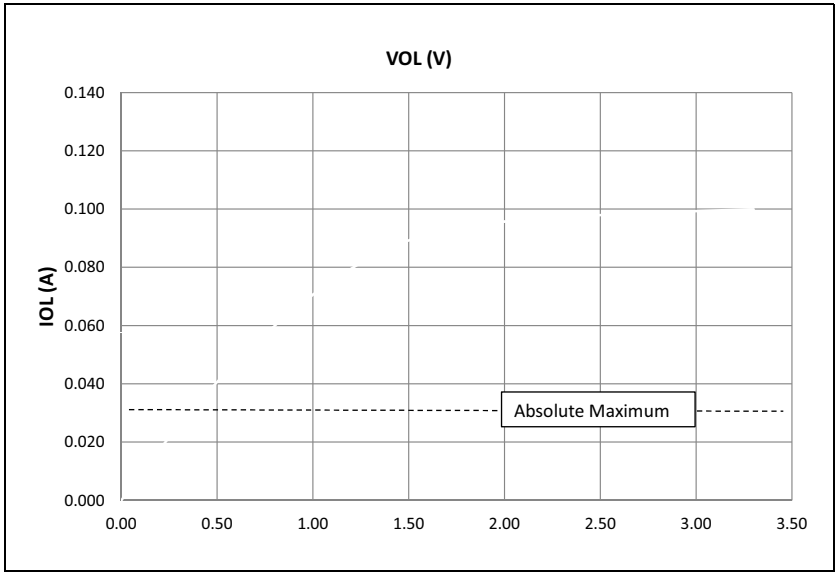
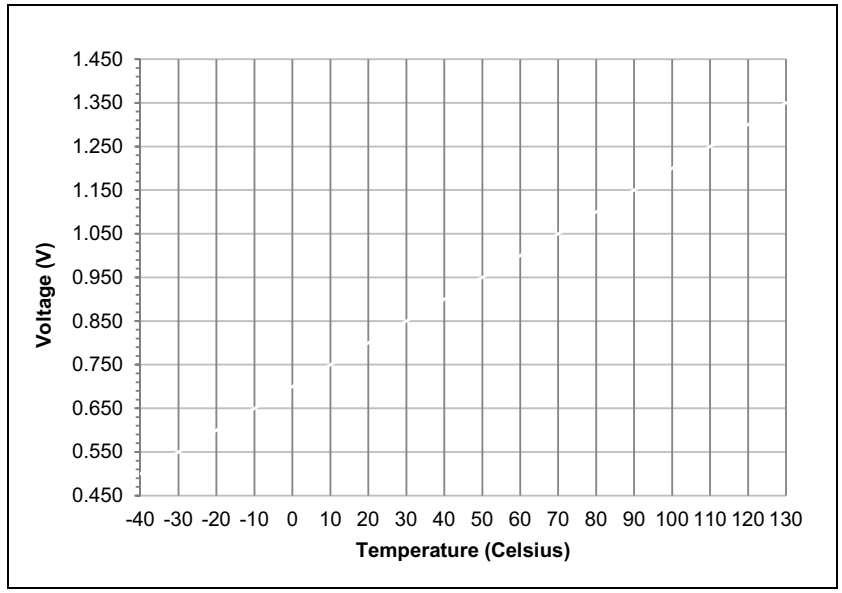
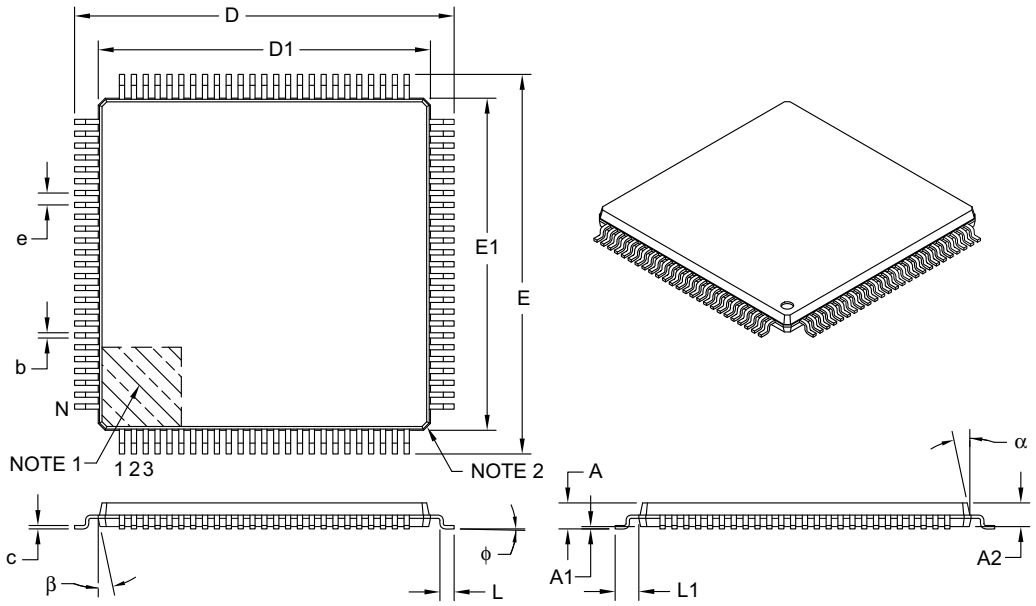


FIGURE 40-7: TYPICAL TEMPERATURE SENSOR VOLTAGE



100-Lead Plastic Thin Quad Flatpack (PF) – 14x14x1 mm Body, 2.00 mm [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Leads	N		100	
Lead Pitch	e		0.50 BSC	
Overall Height	A	–	–	1.20
Molded Package Thickness	A2	0.95	1.00	1.05
Standoff	A1	0.05	–	0.15
Foot Length	L	0.45	0.60	0.75
Footprint	L1		1.00 REF	
Foot Angle	ϕ	0°	3.5°	7°
Overall Width	E		16.00 BSC	
Overall Length	D		16.00 BSC	
Molded Package Width	E1		14.00 BSC	
Molded Package Length	D1		14.00 BSC	
Lead Thickness	c	0.09	–	0.20
Lead Width	b	0.17	0.22	0.27
Mold Draft Angle Top	α	11°	12°	13°
Mold Draft Angle Bottom	β	11°	12°	13°

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Chamfers at corners are optional; size may vary.
3. Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25 mm per side.
4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-110B

TABLE C-1: MAJOR SECTION UPDATES (CONTINUED)

Section Name	Update Description
27.0 "Random Number Generator (RNG)"	The TRNGMODE bit was added to the RNGCON register (see Register 27-2).
28.0 "12-bit High-Speed Successive Approximation Register (SAR) Analog-to-Digital Converter (ADC)"	The S&H Block Diagram was updated (see Figure 28-2). The registers, ADCTRG4 through ADCTRG8, were removed. The bit value definitions for the ADCSEL<1:0> and CONCLKDIV<5:0> bits in the ADCCON3 register were updated (see Register 28-3). The bit names in the ADC Status registers (Register 28-12 and Register 28-13) were updated to match the names in the SFR summary table. The ADCTRGSNS register was updated (see Register 28-26). The POR values were changed in the ADC System Configuration registers (see Register 28-34 and Register 28-35).
34.0 "Special Features"	The FDBGWP bit was removed from the DEVCFG0/ADEVCFG0 registers (see Register 34-3).
37.0 "Electrical Characteristics"	V-Temp (-40°C ≤ TA ≤ +105°C) information was removed from all tables. The operating conditions voltage range was updated in the Absolute Maximum Ratings and in all tables to: 2.1V to 3.6V. Notes on Maximum value operating conditions were added to the Operating, Idle, and Power-Down Current tables (see Table 37-6, Table 37-7, and Table 37-8, respectively). The conditions for System Timing Requirement parameters OS55a and OS55b were updated (see Table 37-18). The Internal FRC Accuracy specifications were updated (see Table 37-20). The Internal LPRC Accuracy specifications were updated (see Table 37-21). The ADC Module Specifications were updated (see Table 37-38). The Analog-to-Digital Conversion Timing Requirements were updated (see Table 37-39).
Appendix B: "Migrating from PIC32MZ EC to PIC32MZ EF"	This appendix was added, which provides an overview of considerations for migrating from PIC32MZ EC devices to the PIC32MZ EF family of devices.
Product Identification System	V-Temp (-40°C ≤ TA ≤ +105°C) information was removed.